

**dsPIC33AK512MPS512 Family  
Silicon Errata and Data Sheet Clarification**

The dsPIC33AK512MPS512 family devices that you have received conform functionally to the current device data sheet (DS70005591A), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.


The errata described in this document will be addressed in future revisions of dsPIC33AK512MPS512 family silicon.

**Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (A1).

Data sheet clarifications and corrections start on Page 8, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers and emulation tools, which are available at the Microchip corporate website ([www.microchip.com](http://www.microchip.com)).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with a hardware debugger:

1. Using the appropriate interface, connect the device to the hardware debugger.
2. Open an MPLAB IDE project.
3. Configure the MPLAB IDE project for the appropriate device and hardware debugger.
4. Based on the version of MPLAB IDE you are using, do one of the following:
  - a) For MPLAB IDE 8, select *Programmer > Reconnect*.
  - b) For MPLAB X IDE, select *Window > Dashboard* and click the **Refresh Debug Tool Status** icon (  ).
5. Depending on the development tool used, the part number *and* Device Revision ID value appear in the **Output** window.

**Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The DEVREV values for the various silicon revisions of the dsPIC33AK512MPS512 family are shown in Table 1.

**TABLE 1: SILICON DEVREV VALUES**

Part Number	Device ID <sup>(1)</sup>	Revision ID for Silicon Revision <sup>(1)</sup>	Part Number	Device ID <sup>(1)</sup>	Revision ID for Silicon Revision <sup>(1)</sup>
		A1			A1
dsPIC33AK512MPS512	0xA77C	01h	dsPIC33AK256MPS206	0xA719	01h
dsPIC33AK512MPS510	0xA77B		dsPIC33AK256MPS205	0xA718	
dsPIC33AK512MPS508	0xA77A		dsPIC33AK512MC510	0xA763	
dsPIC33AK512MPS506	0xA779		dsPIC33AK512MC508	0xA762	
dsPIC33AK512MPS505	0xA778		dsPIC33AK512MC506	0xA761	
dsPIC33AK256MPS512	0xA75C		dsPIC33AK512MC505	0xA760	
dsPIC33AK256MPS510	0xA75B		dsPIC33AK256MC510	0xA743	
dsPIC33AK256MPS508	0xA75A		dsPIC33AK256MC508	0xA742	
dsPIC33AK256MPS506	0xA759		dsPIC33AK256MC506	0xA741	
dsPIC33AK256MPS505	0xA758		dsPIC33AK256MC505	0xA740	
dsPIC33AK512MPS212	0xA73C		dsPIC33AK512MC210	0xA723	
dsPIC33AK512MPS210	0xA73B		dsPIC33AK512MC208	0xA722	
dsPIC33AK512MPS208	0xA73A		dsPIC33AK512MC206	0xA721	
dsPIC33AK512MPS206	0xA739		dsPIC33AK512MC205	0xA720	
dsPIC33AK512MPS205	0xA738		dsPIC33AK256MC210	0xA703	
dsPIC33AK256MPS212	0xA71C		dsPIC33AK256MC208	0xA702	
dsPIC33AK256MPS210	0xA71B		dsPIC33AK256MC206	0xA701	
dsPIC33AK256MPS208	0xA71A		dsPIC33AK256MC205	0xA700	

**Note 1:** Refer to the "dsPIC33AK512MPS512 Family Flash Programming Specification" for detailed information on Device and Revision IDs for your specific device.

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**TABLE 2: SILICON ISSUE SUMMARY**

Module	Feature	Item Number	Issue Summary	Affected Revisions <sup>(1)</sup>
				A1
CPU	PCTRAP	1.	PCTRAP captures the trap origination address of a math error trap even when disabled.	X
DMA	Bus Read Error	2.	DMA Bus Read Error Fault bit not set.	X
PWM	PCI	3.	PCI active is not terminated in latched edge detection modes.	X
PWM	Complementary Mode	4.	Software Override priority is not maintained over current limit PCI (CLPCI).	X
PWM	Complementary Mode	5.	Dead time is not applied properly when the PCI active signal is deasserted for a short time of 1-2 PWM clock cycles.	X
PWM	PCI	6.	PCI SR latch does not reset in RESET Dominant mode.	X
PWM	EOC	7.	In Retriggerable mode, EOC event is not blocked when the retrigger event is close to EOC.	X
PWM	LEB	8.	LEB active signal asserts for 2 clocks less than programmed.	X
PWM	Time Base Capture	9.	Manual time base capture fails after first capture event.	X
PWM	TRIGx	10.	When TRIGx = EOC and CAHALF is changed by software, a trigger event can occur in the opposite phase.	X
PWM	PCI	11.	In Complementary Output mode, when PSYNC is enabled in PCI Edge Detect mode, PCI override can be applied twice.	X
ITC	CVD Array	12.	Make-before-break issue with CVD/cap array.	X
ITC	RX Guard Pins	13.	Guard settings in ITCRECx registers control the wrong pins.	X
QEI	Index Event	14.	Index event is missed when clock divider (INTDIV[2:0]) is configured for greater than 1.	X
ITC	Index Counter	15.	Position counter is loaded with 0x00000001 on an index event for PIMOD[2:0] = 0b001.	X
QEI	Buffer Overflow	16.	Address not causing the buffer overflow in Address Detect mode.	X
CCP	Output	17.	When ASDGM = 1, the CCP generates an output with shutdown gate input at 0.	X
CCP	Capture	18.	When CCSEL = 1 and IGSM = 1, CCP will capture the timer value without an edge.	X
PTG	Software Trigger	19.	PTGSWT bit is not cleared in hardware.	X
PWM	ADC Trigger Events	20.	In LLC mode, when TRIGy is equal to EOC and with CAPTREN set, ADC triggers are not generated when ADC trigger source is TRIGy.	X
DAC	DACOUT Buffers	21.	Both DAC output buffers are non-linear near the supply rails.	X
CPU	Trap	22.	Address error trap generated on legal indirect+offset move.	X
GPIO	IO Current Limit	23.	Source/Sink capability of IO pins is less than electrical specifications.	X
SPI	Ignore Overflow	24.	SPI receiver does not continue to run on overflow with Ignore Overflow bit set.	X
SILICON	Silicon Temperature Variants	25.	Silicon only supports I-temp (-40°C to 85°C) and not for E-temp (-40°C to 125°C).	X

**Note 1:** Only those issues indicated in the last column apply to the current silicon revision.

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## Silicon Errata Issues

**Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (A1).

### 1. Module: CPU

In any trap event, the trap origination address register (PCTRAP) is loaded with the value of the Program Counter (PC) associated with the instruction that caused the trap. However, it is not expected to capture the trap origination address for math error traps when they are disabled.

#### Work around

None. Alternatively, enable math error traps, ignore the PCTRAP value and clear PCTRAP before exiting the math error trap handler. This re-enables the PCTRAP to capture the trap origination address of any other traps.

#### Affected Silicon Revisions

A1								
X								

### 2. Module: DMA

To initiate a read error trap, it is necessary to activate the Read Error Trap Enable (RETEN) bit. Upon setting the RETEN bit, a read error trap is triggered, which concurrently sets the DMA Bus Read Error Fault bit (DMASSTATx.DMAFLT2) to high. Conversely, if the RETEN bit is not enabled, the DMA Bus Read Error Fault bit (DMAS-TATx.DMAFLT2) will not be set. Therefore, to guarantee the detection of bus read errors in the DMA through the Bus Read Fault bit, RETEN needs to be enabled, although this action may result in the generation of undesired traps.

#### Work around

Set the RETEN bit explicitly in the application software. When the trap is generated, ignore it and exit from the respective ISR.

#### Affected Silicon Revisions

A1								
X								

### 3. Module: PWM

PCI Active signal is not terminated immediately when PCI synchronization is enabled, termination synchronization is disabled, and latch is operated in set dominant mode.

#### Work around

When using PCI Latched modes, do not use PCI source select synchronization (PSYNC) when TERM synchronization is disabled (TSYNCDIS = 1).

#### Affected Silicon Revisions

A1								
X								

### 4. Module: PWM

The Software Override priority is not maintained over the current limit PCI (CLPCI).

#### Work around

Use another PCI instance with a higher priority than the current limit, such as the Fault PCI.

#### Affected Silicon Revisions

A1								
X								

### 5. Module: PWM

Dead time is not applied properly when the PCI active signal is deasserted for a short time of 1-2 PWM clock cycles.

#### Work around

1. Ensure the PCI active signal does not have a deassertion period of less than 4 PWM clock cycles.
2. Use EOC synchronization or Latched modes to control the timing of PCI deassertion.

#### Affected Silicon Revisions

A1								
X								

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## 6. Module: PWM

When the PCI input is high, the PCI Active signal is terminated even when there is no termination signal.

### Work around

None. Only the PCI active signal is affected and the PWM outputs remain halted.

### Affected Silicon Revisions

A1								
X								

## 7. Module: PWM

In Retriggerable mode, the EOC event is not blocked when the retrigger event is close to EOC.

### Work around

Ensure that the retrigger event is 64 PWM clock cycles before EOC.

### Affected Silicon Revisions

A1								
X								

## 8. Module: PWM

The LEB active signal is asserted for 2 clocks less than the programmed value.

### Work around

Add 2 to calculated LEB register value before programming.

### Affected Silicon Revisions

A1								
X								

## 9. Module: PWM

Manual time base capture fails after the first capture event.

### Work around

Use hardware capture for the first capture event. Select the PCI input as the capture source and generate a capture event. Subsequent captures can be triggered in software.

### Affected Silicon Revisions

A1								
X								

## 10. Module: PWM

A trigger event is generated at the wrong phase when the trigger value is programmed to be equal to EOC, and the trigger compare event time (CAHALF) is changed on the fly.

### Work around

The minimum difference between EOC and trigger values should be at least 64.

### Affected Silicon Revisions

A1								
X								

## 11. Module: PWM

In Complementary Output mode, when PSYNC is enabled in PCI Edge Detect mode, PCI override can be applied twice.

### Work around

1. Ensure that the PCI active signal does not have a deassert period of less than 4 PWM clock cycles.
2. Use EOC synchronization or Latched modes to control the timing of PCI deassertion.

### Affected Silicon Revisions

A1								
X								

## 12. Module: ITC

The charge and discharge switches may be make-before-break and not completely open before the balance switch of the CVD array is closed.

### Work around

Use additional sequence steps, where all switches are open, should be added to acquisition sequence.

### Affected Silicon Revisions

A1								
X								

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## 13. Module: ITC

The guard settings in the ITCRECx registers control the incorrect pins.

### Work around

Do not use active guards in the ITCRECx register.

### Affected Silicon Revisions

A1							
X							

## 14. Module: QEI

When the QEI is configured with Position Counter Initialization Mode bits (PIMOD[2:0]) equal to 0b001, 0b010, 0b011, 0b100 or 0b111, any index event initializes the position counter. However, if the clock divider value configured by the INTDIV[2:0] bits is greater than 1, and if the index event occurs between two clock edges, the index event will be missed.

### Work around

The index pulse width should be sufficiently high enough so that the event is captured by the QEI clock.

### Affected Silicon Revisions

A1							
X							

## 15. Module: ITC

When QEI is configured in Quadrature mode (CCM[1:0] = 0b00) with PIMOD[2:0] = 0b001, any index event is supposed to reset the position counter. However, an index event will not reset the position counter; instead, it will be loaded with 0x00000001.

### Work around

The user application can enable an interrupt on the index event and load the position counter with zero. The index event should be sufficiently large enough to allow the software to reset the position counter before the next count-up or count-down pulse.

### Affected Silicon Revisions

A1							
X							

## 16. Module: QEI

In Address Detect mode, the address byte does not cause the buffer overflow if an address is received when the RX buffer is full.

### Work around

Read the data from the RX buffer before it becomes full.

### Affected Silicon Revisions

A1							
X							

## 17. Module: CCP

When ASDGM = 1 and shutdown gate input is low (OCFx = 0), the CCP output is still generated.

### Work around

Read the auto shutdown fault RP pin through the LAT register bits, and if the LAT value reads as zero, use the CCP Software Shutdown/Gate Control bit to turn off the CCP.

### Affected Silicon Revisions

A1							
X							

## 18. Module: CCP

When CCP is configured for input capture and One-Shot mode (IGSM = 1), the CCP will capture the timer value without an edge.

### Work around

Once CCP is turned ON, and before enabling gate capture, re-arm the capture module using Input Capture Gate Arm bit.

### Affected Silicon Revisions

A1							
X							

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## 19. Module: PTG

When executing back-to-back “wait for software trigger” step commands, the PTGSWT bit is not cleared by hardware.

### Work around

Manually clear the PTGSWT bit before setting it again between the two PTGSW trigger commands.

### Affected Silicon Revisions

A1							
X							

## 20. Module: PWM

In LLC mode, when TRIGy is equal to EOC and with CAPTREN set, ADC triggers are not generated when the ADC trigger source is TRIGy.

### Work around

Program initial TRIGy value with 50% of EOC value.

### Affected Silicon Revisions

A1							
X							

## 21. Module: DAC

Both DAC output buffers are non-linear near the supply rails. As a result, the DAC's electrical specifications can be greatly affected when using the DAC output buffers.

### Work around

Use the UREF module to route DAC1-DAC7 signals to the UREF output pin. The following is an example of how to route the DAC signal through the UREF:

```
// Input to UREF is set to DAC1
UREFCONbits.INSEL = 6;

// Output from UREF is set to UREF pin
UREFCONbits.OUTSEL = 1;

// Turn UREF module on
UREFCONbits.ON = 1;
```

### Affected Silicon Revisions

A1							
X							

## 22. Module: CPU

An address error trap is generated in Indirect Register Offset Addressing mode (represented as [Ws + Wb] within instructions) when the value of Ws (Source) used is beyond 24 bits wide (size of the address path). The issue may occur even when the effective address (Ws + Wb) is a valid address.

### Work around

Either of the following workarounds can be used to overcome the issue:

1. Define the value of Ws within the 24-bit address range.
2. When using the XC-DSC V3.20 or newer C Compiler for dsPIC® DSCs, enable the compiler option: `-merrata=base_offset` (Project Properties>XC\_DSC>xc-dsc-gcc>Additional options).

### Affected Silicon Revisions

A1							
X							

## 23. Module: GPIO

When a GPIO is configured as an output and driven low, if an external signal sinks more than 8.7mA of current into a 4x pin, or 11.6mA on an 8x pin, the pin may become damaged.

Similarly, when a GPIO is configured as an output and driven high, if an external signal sources more than 5.8mA of current from a 4x pin, the pin may become damaged. 8x pins are not affected by this condition.

### Work around

If an I/O is configured as an output and driven high or low, limit the current to or from the pin with a series resistor, or avoid direct pin contention scenarios.

### Affected Silicon Revisions

A1							
X							

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## 24. Module: SPI

In the event of an overflow, the SPI reception is suspended when the Ignore Overflow bit is activated, and the SPIROV bit is not cleared.

### Work around

Clear the SPIROV bit during the reception of the next byte that triggers the overflow. Additionally, SPIBUF must be read at least once.

### Affected Silicon Revisions

A1								
X								

## 25. Module: SILICON

Silicon only supports I-temp (-40°C to 85°C) and not E-temp (-40°C to 125°C).

### Affected Silicon Revisions

A1								
X								

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## Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS70005591A).

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

None.

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## APPENDIX A: DOCUMENT REVISION HISTORY

Rev B Document (05/2025)

Updated silicon issue 25. ([SILICON](#))

Rev A Document (05/2025)

Initial version of this document; issued for silicon revision A1.

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